

# N- and P-Channel 60-V (D-S) MOSFET

PRODUCT SUMMARY					
	$V_{DS}(V)$	R <sub>DS(on)</sub> (Ω)	I <sub>D</sub> (A) <sup>a</sup>	Q <sub>g</sub> (Typ.)	
N-Channel	60	0.030 at V <sub>GS</sub> = 10 V	35	6 nC	
		0.033 at V <sub>GS</sub> = 4.5 V	30	0110	
P-Channel	- 60	0.050 at V <sub>GS</sub> = - 10 V	- 19	8 nC	
		0.060 at V <sub>GS</sub> = - 4.5 V	- 15	0110	



Top View

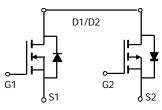
Drain Connected to Tab

#### FEATURES

- Halogen-free According to IEC 61249-2-21
  Available
- TrenchFET<sup>®</sup> Power MOSFET
- 100 %  $R_g$  and UIS Tested

#### **APPLICATIONS**

CCFL Inverter



N-channel

P-channel

ABSOLUTE MAXIMUM RATINGS (TA = 25°C UNLESS OTHERWISE NOTED)							
Parameter		Symbol	Nch Limit	Pch Limit	Units		
Drain-Source Voltage			60	-60	V		
Gate-Source Voltage			±20	±20	V		
Continuous Drain Current <sup>a</sup>	T <sub>C</sub> =25°C	I <sub>D</sub>	35	-20	А		
Pulsed Drain Current <sup>b</sup>		I <sub>DM</sub>	140	-80	~		
Continuous Source Current (Diode Conduction) <sup>a</sup>	T <sub>C</sub> =25°C	۱ <sub>s</sub>	35	-20	А		
Power Dissipation <sup>a</sup>	T <sub>C</sub> =25°C	PD	50	50	W		
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub>	T <sub>J</sub> , T <sub>stg</sub>	-55 to 175	°C		

THERMAL RESISTANCE RATINGS			
Parameter	Symbol	Maximum	Units
Maximum Junction-to-Ambient <sup>c</sup>	R <sub>θJA</sub>	<sub>eja</sub> 50 °C/W	
Maximum Junction-to-Case		3	0/11

Notes

- a. Package Limited
- b. Pulse width limited by maximum junction temperature
- c. Surface Mounted on 1" x 1" FR4 Board.



HALOGEN

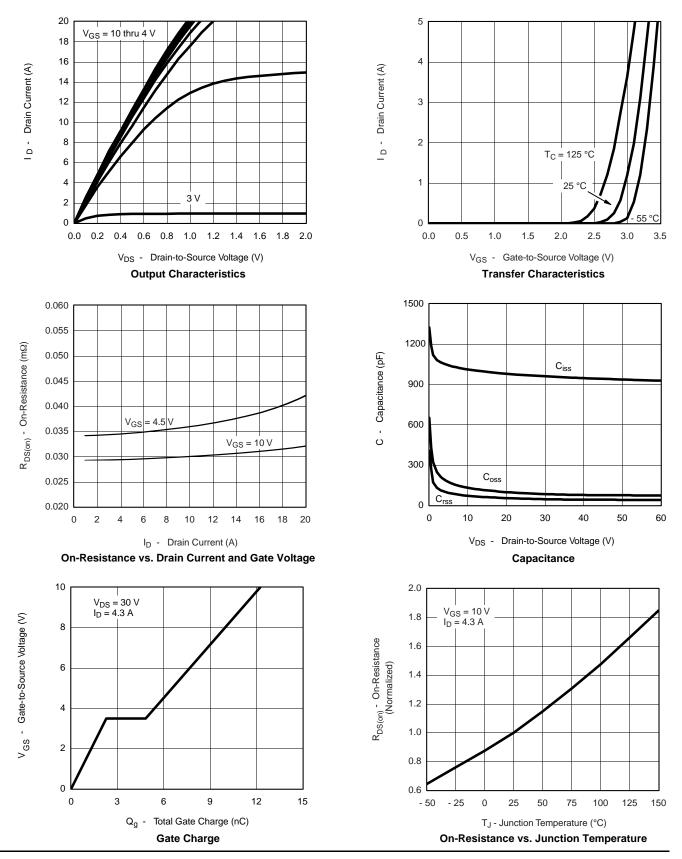
**FREE** Available



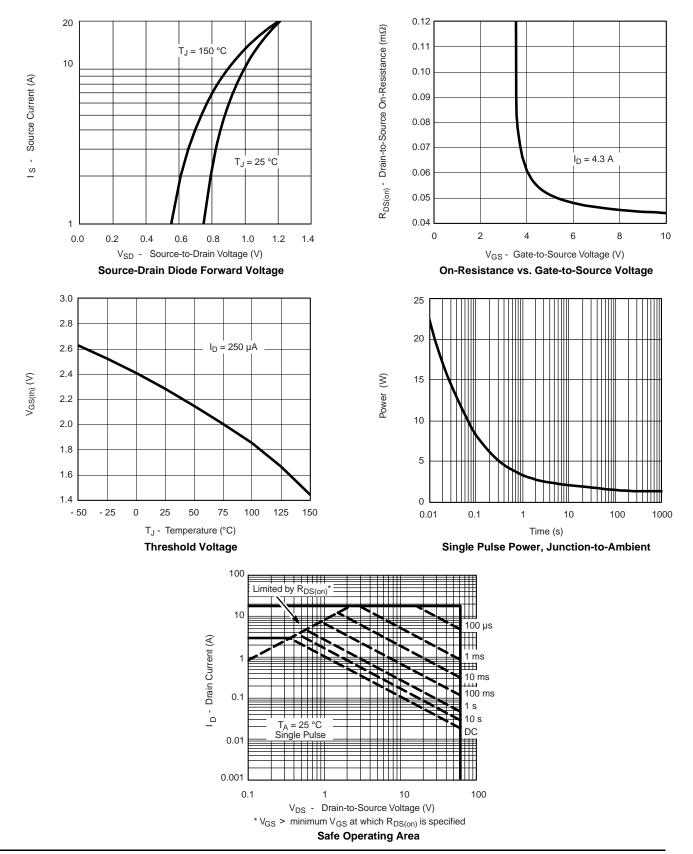


Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit	
Static							
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_D = 250 \text{ uA}$	1		3	V	
		$V_{DS} = V_{GS}, I_{D} = -250 \text{ uA}$	-1		-3	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			±100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 60 \text{ V}, V_{GS} = 0 \text{ V}$			1	uA	
		$V_{DS} = -48 \text{ V}, V_{GS} = 0 \text{ V}$			-1		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} = 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	45			А	
	•D(on)	$V_{DS} = -5 V, V_{GS} = -10 V$	-25			А	
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		30		mΩ	
Drain-Source On-Resistance <sup>a</sup>	r <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 16 \text{ A}$		33			
Drain-Source On-Resistance	• DS(on)	V <sub>GS</sub> = -10 V, I <sub>D</sub> = -10 A		50		mΩ	
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -8 \text{ A}$		60			
Forward Transconductance <sup>a</sup>	<b>g</b> <sub>fs</sub>	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		15		S	
	9ts	$V_{DS} = -15 \text{ V}, \text{ I}_{D} = -10 \text{ A}$		11		S	
Diode Forward Voltage <sup>a</sup>	V <sub>SD</sub>	I <sub>S</sub> = 17 A, V <sub>GS</sub> = 0 V		0.89		V	
	• 30	I <sub>S</sub> = -10 A, V <sub>GS</sub> = 0 V		-0.98		V	
		Dynamic <sup>b</sup>					
Total Gate Charge	Qg	N - Channel		9		nC	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 30 \text{ V}, V_{GS} = 4.5 \text{ V},$		3			
Gate-Drain Charge	Q <sub>gd</sub>	I <sub>D</sub> = 20 A		4			
Turn-On Delay Time	t <sub>d(on)</sub>	N - Channel		5			
Rise Time	t <sub>r</sub>	$V_{DS} = 30 \text{ V}, \text{ R}_{L} = 1.5 \Omega,$		5		ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_{\rm D} = 20  {\rm A},$		27			
Fall Time	t <sub>f</sub>	$V_{GEN}$ = 10 V, $R_{GEN}$ = 6 $\Omega$		8			
Input Capacitance	C <sub>iss</sub>	N - Channel		1500		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = 15 V, V_{GS} = 0 V, f = 1 Mhz$		84			
Reverse Transfer Capacitance	C <sub>rss</sub>			79			
Total Gate Charge	Qg	P - Channel		10			
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 4.5 \text{ V},$		5		nC	
Gate-Drain Charge	Q <sub>gd</sub>	I <sub>D</sub> = -10 A		4			
Turn-On Delay Time	t <sub>d(on)</sub>	P - Channel		5			
Rise Time	t <sub>r</sub>	$V_{DS} = -30 \text{ V}, \text{ R}_{L} = 3 \Omega,$		4		ns	
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_{\rm D} = -10 \text{ A},$		30			
Fall Time	t <sub>f</sub>	$V_{GEN}$ = -10 V, $R_{GEN}$ = 6 $\Omega$		11			
Input Capacitance	C <sub>iss</sub>	P - Channel		1180		] ]	
Output Capacitance	C <sub>oss</sub>	$V_{DS} = -15 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ f} = 1 \text{ Mhz}$		84		pF	
Reverse Transfer Capacitance	C <sub>rss</sub>			60			

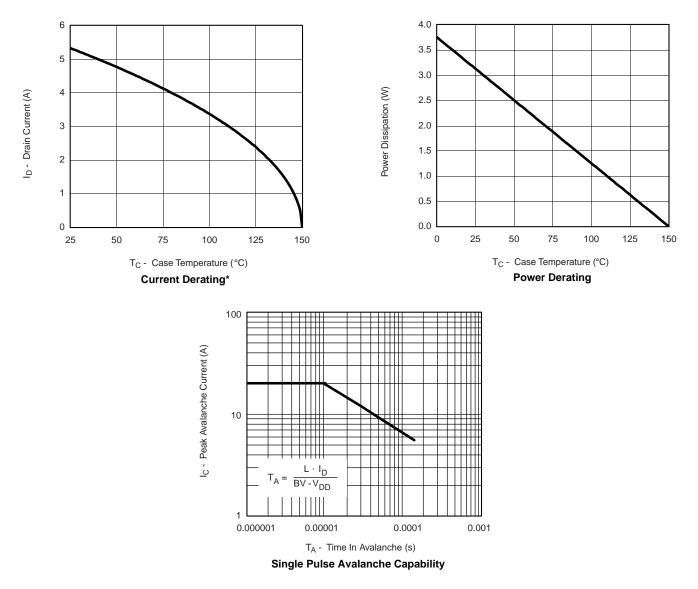






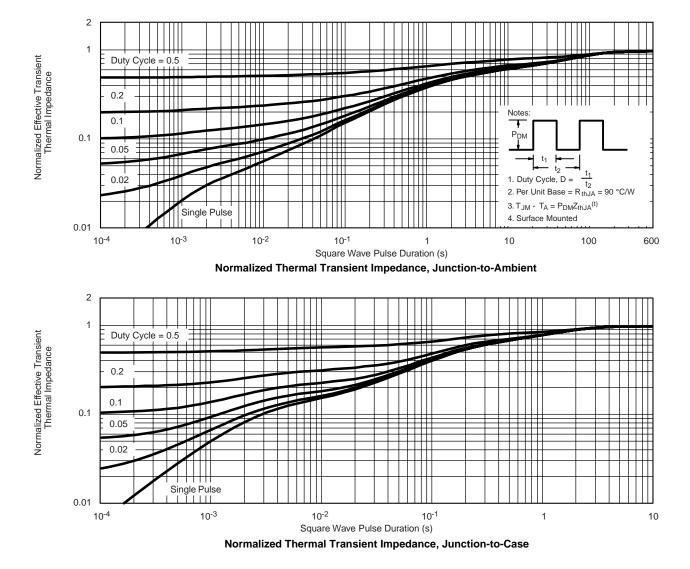






\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

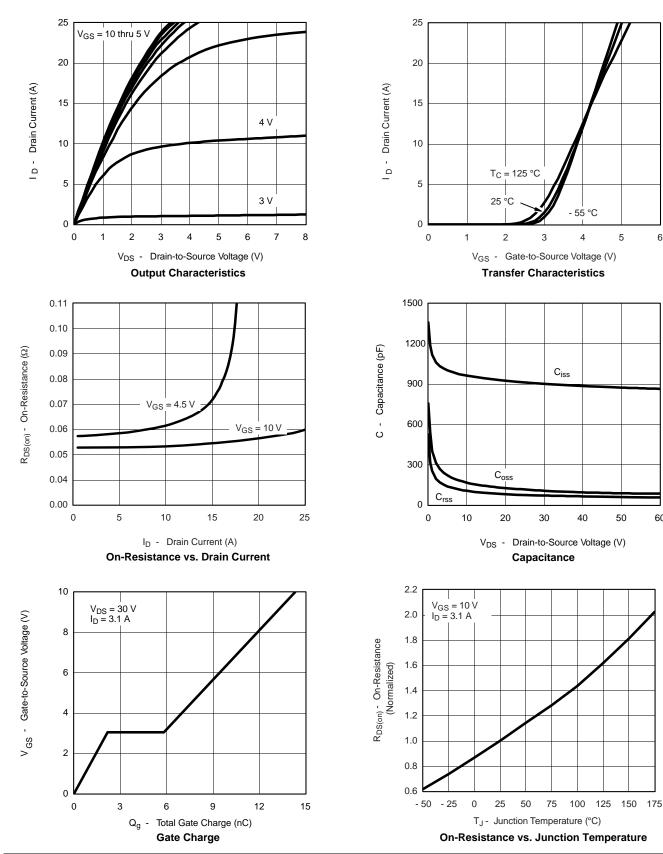




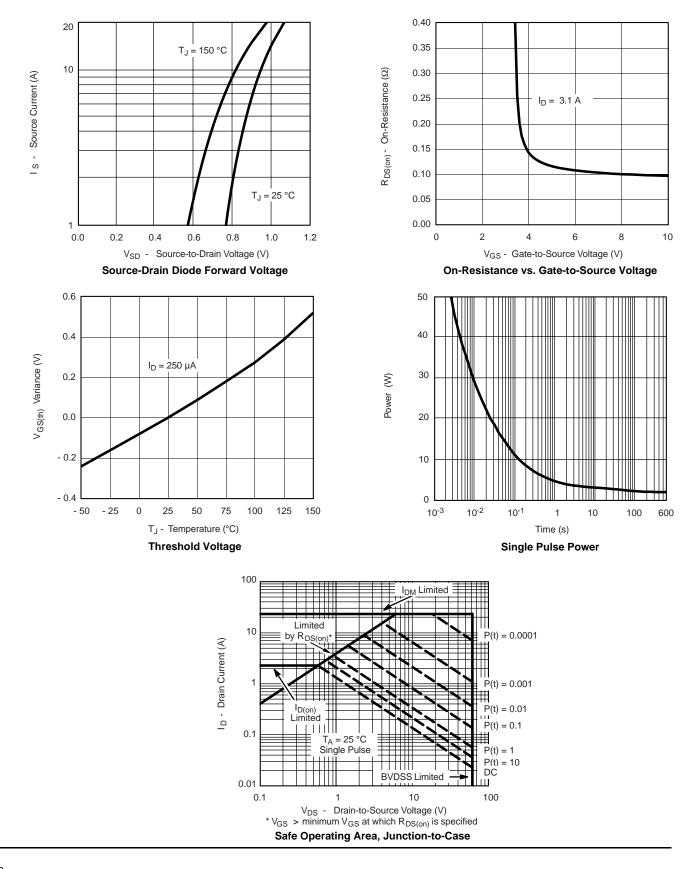


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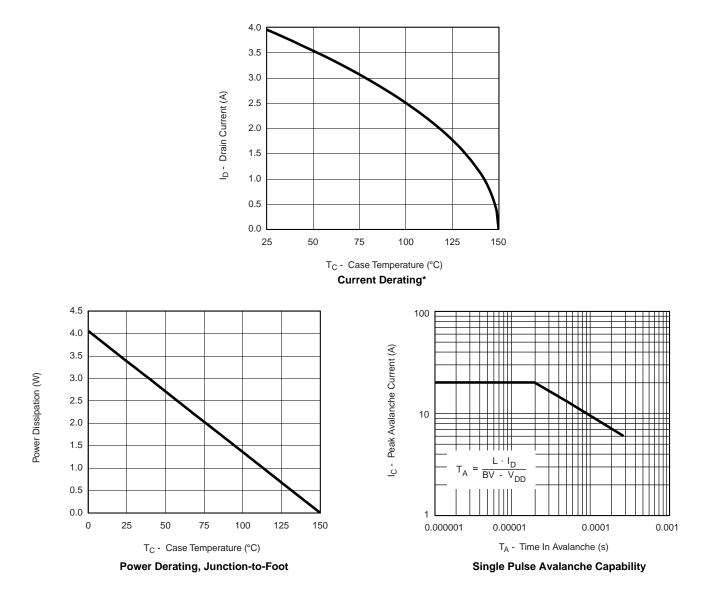
60





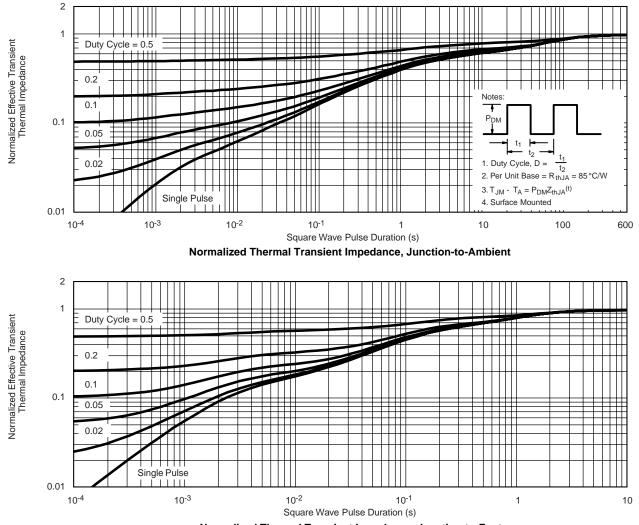






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Normalized Thermal Transient Impedance, Junction-to-Foot

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